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Mail Stop Amendment
Commissioner for Patents

P.O. Box 1450

Alexandria, VA 223/13-1450

on Sale. 8, 30

TOWNSEND and TOWNSEND and CREW LLP

Bv:

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of:

William R. ASHURST et al.

Application No.: 10/086,652

Filed: February 28, 2002

For: VAPOR DEPOSITION OF

DIHALODIALKYLSILANES

Customer No.: 20350

Confirmation No. 6884

Examiner:

Markham, Wesley D.

Technology Center/Art Unit: 1762

DECLARATION OF WILLIAM R. ASHURST UNDER 37 CFR §1.131 WITH CONFIRMATION BY CO-INVENTORS

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

- I, WILLIAM R. ASHURST, hereby declare as follows:
- 1. I am the William R. Ashurst listed as the first-named inventor in the above-identified patent application. I have reviewed the document bearing the caption "AMENDMENT NO. 1" including the amendment to the claims of the application.
- 2. Attached hereto as Exhibits A and B are true copies, except that dates have been blocked out, of pages from a laboratory notebook or notebooks maintained by me, the

entries on these pages having been made by me. The drawing and entries on Exhibit A are notes taken during a conference between myself and one of my coinventors on this patent application, and the entries on Exhibit B are accurate descriptions of materials and processing conditions that I used. The drawing on Exhibit A and the entries on both Exhibits describe coating procedures and materials that fall within the scope of claim 1 of the patent application. Both notebook pages were completed prior to May 7, 2001.

3. A transcription and explanations of the entries on Exhibit B, line by line, are set forth below:

Entry	Explanation
"VapSAM coater"	This indicates that the type of experiment was a vapor coating process.
"Processing WRA0067 & WRA0068"	These are code numbers that I assigned, using as a format my initials followed by four digits.
"Sandia Reticle 156"	This refers to micromachine chips produced at Sandia National Laboratories, layout no. TP156.
"Standard release:"	This refers to the release procedure set forth in the succeeding lines.
"90 m HF/HC1"	The first step was a 90-minute exposure of the chips to an etchant containing HF and HCl.
"Water Rinse"	
"H <sub>2</sub> O <sub>2</sub> xfer"	The chips were exposed to $H_2O_2$ to partially oxidize the surfaces to facilitate their transfer to the de-scumming solution.
"Descum @ 70°C 10 m"	The chips were treated in a de-scumming solution containing ammonia, H <sub>2</sub> O <sub>2</sub> and water at 70°C for ten minutes.
"H <sub>2</sub> O <sub>2</sub> @ 80°C 10 m"	The chips were immersed in H <sub>2</sub> O <sub>2</sub> at 80°C for ten minutes to make sure that the surfaces were clean and oxidized.

		$\cdot$
	"Water Rinse & Dry"	
	"Chiplet + WRA0068 >> VapSAM (DDMS)"	A "chiplet" (i.e., a small piece of Si(100) wafer) and one micromachine sample were placed in a vapor coater apparatus.
	"Chiplet + WRA0068 put in VapSAM"	Same as above.
	"Pumpdown < 1 × 10 <sup>-4</sup> "	After the samples were placed in the chamber of the vapor coater apparatus, the chamber was evacuated to a pressure reading of less than 0.1 milliTorr.
•	"heatup ~ 35°C"	Mild heating was applied to elevate the sample temperature to about 35°C.
	"expose 2 torr $H_2O + 1$ torr DDMS for 5 m"	Water vapor was added to the chamber to a pressure of 2 Torr; DDMS vapor was then added until the pressure reading was 1 Torr greater (for a total of 3 Torr), and this condition was held for 5 minutes.
	"Pumpdown < 1 × 10 <sup>-4</sup> "	The chamber was then evacuated to a pressure reading of less than 0.1 milliTorr.
	"T = 43°C"	The sample temperature as measured was 43°C.
	"expose 2.2 torr $H_2O + 1.1$ torr DDMS for 20 m"	Water vapor was added to the chamber until the pressure reading was 2.2 Torr; DDMS was then added until the pressure reading was 1.1 Torr greater (for a total of 3.3 Torr) and these conditions were then held for 20 minutes.
	"Pumpdown < 1 × 10 <sup>-4</sup> "	The chamber was again evacuated to a pressure reading of less than 0.1 milliTorr.
	"N <sub>2</sub> backfill"	The chamber was then vented with dry nitrogen gas until the pressure was atmospheric.

The samples were removed from the chamber and the

water contact angle on the Si(100) chiplet was

immediately measured to be 100°.

water < chiplet = 100°"

"remove

ASHURST et al., Application No. 10/086,652 Examiner: Markham, W.D.; Art Unit 1762 DECLARATION OF WILLIAM R. ASHURST UNDER 37 CFR §1.131 WITH CONFIRMATION

4. I further declare that the above statements were made with the knowledge that willful false statements and the like are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States Code, and that any such willful false statement may jeopardize the validity of the subject patent application or any patent resulting therefrom.

Date: Feb. 7, 2005 By: W.M.

We, the co-inventors of William R. Ashurst, confirm that to the best of our knowledge the statements above are true. We likewise declare that this statement is being made with the knowledge that willful false statements and the like are punishable by fine or imprisonment or both, under Section 1001 of Title 18 of the United States Code, and that any such willful false statement may jeopardize the validity of the subject patent application or any patent resulting therefrom.

Date:	_ By:_	Roya Maboudian	
Date:	_ By:_	Carlo Carraro	
Date:	_ By:_	Wilhelm Frey	,
Attachments: Exhibits A and B			

MHH:mhh

60362143 v1

ASHURST et al., Application No. 10/086,652 Examiner: Markham, W.D.; Art Unit 1762

DECLARATION OF WILLIAM R. ASHURST UNDER 37 CFR §1.131 WITH CONFIRMATION

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Date:	By:	•
	- v	William R. Ashurst
We, the co-invento	ors of W	villiam R. Ashurst, confirm that to the best of our
knowledge the statements above a	ire true.	We likewise declare that this statement is being made
with the knowledge that willful fa	lse state	ements and the like are punishable by fine or
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such willful false statement may j	eopardi	ze the validity of the subject patent application or any
patent resulting therefrom.		• •
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Date: Nov. 30, 2004	By:	Ange men.
		Roya Maboudian
ih 20 10010	<b>.</b>	Couls Comas
Date: 190-30, 2004	_ By:	Carlo Carraro
Date:	By:_	337:11 1 T
· · ·		Wilhelm Frey
Attachments: Exhibits A and B		
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ASHURST et al., Application No. 10/086,652 Examiner: Markham, W.D.; Art Unit 1762

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Date:	By:
,	William R. Ashurst
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imprisonment or both, under Sect	tion 1001 of Title 18 of the United States Code, and that any
such willful false statement may j	jeopardize the validity of the subject patent application or any
patent resulting therefrom.	
•	
•	
Date:	By:
	Roya Maboudian
•	
Date:	By: Carlo Carraro
	^
Date: Nov 24, 2004	By: Dullelin Aun
•	Wilhelm Frey
Attachments: Exhibits A and B	
MHH:mhh 60362143 v1	· · · · · · · · · · · · · · · · · · ·

Meety W/ Will Frey of BOSH HF/H20 **EXHIBIT** A

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	Sandia retille 150
	90 HE/11()
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	11 0 6 45°C 10 C
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	Chipiet + WRAOO68 >> VarsAM (DDMS)
,	CHIPTEN F WINTOON O 17 VAY STITE ( CODITY S)
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	Pumpowin ( 1X0)
	heatup ~ 35°(
	expose 2 tors M20 + 1 tors DDMs for 5ini
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	No backt. 11
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	EXHIBIT
	<b>§</b> B

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